

PATENT ASSIGNMENT

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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT
CONVEYING PARTY DATA	
Name	Execution Date
Masato HIDAKA	06/11/2008
RECEIVING PARTY DATA	
Name:	SMK CO., LTD.
Street Address:	830-5, Ooi, Tsukui-cho, Sagamihara-shi
City:	Kanagawa
State/Country:	JAPAN
Postal Code:	220-0202
PROPERTY NUMBERS Total: 1	
Property Type	Number
Application Number:	29328257
CORRESPONDENCE DATA	
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ATTORNEY DOCKET NUMBER:	08-11-2075
NAME OF SUBMITTER:	Lee Fredric Sharra
Total Attachments: 1 source=08-11-2075_Assignment#page1.tif	

OP \$40.00 29328257

ASSIGNMENT

In consideration of value received,

Masato HIDAKA

hereinafter referred to as "Assignor", sell and assign to

SMK CO., LTD.

a corporation of **Kanagawa, Japan**, having a place of business at

830-5, Ooi, Tsukui-cho, Sagami-hara-shi, Kanagawa 220-0202 Japan

, respectively, its successors, assigns or nominees, hereinafter referred to as "Assignee", the entire right, title and interest in and to an invention entitled:

Lower electrode structure for welding

invented by the Assignor and as described in the following:

and in and to all applications for patent for said invention in all countries, and all divisions, reissues, continuations and extensions of any of said applications, and all rights of priority resulting from the filing of any of said applications; and Assignor authorizes and requests any official whose duty is to issue patents, to issue any patent on said invention or resulting therefrom to said Assignee, and Assignor agrees that on request and without further consideration, but at the expense of said Assignee, Assignor will communicate to said Assignee or its representatives any facts known to Assignor respecting said invention and testify in any legal proceeding, sign all lawful papers, execute all divisional, continuing or other applications, make all rightful oaths and declarations, and generally do everything possible to aid said Assignee to obtain and enforce a proper patent protection for said invention in all countries.

Subscribed and executed at **Kanagawa, Japan**
(City and Country)

06/11/2008
Date

Masato Hidaka
Assignor: **Masato HIDAKA**

Date

Assignor:

Date

Assignor:

Date

Assignor: